

Product data sheet

1. General description

Planar passivated very sensitive gate four quadrant triac in a TO92 plastic package intended for use in applications requiring direct interfacing to logic ICs and low power gate drivers.

2. Features and benefits

- High blocking voltage capability
- Very sensitive gate
- · Planar passivated for voltage ruggedness and reliability
- Triggering in all four quadrants
- Direct interfacing to logic level ICs
- Direct interfacing to low power gate drive circuits

3. Applications

- Industrial process control
- General purpose low power motor control
- Home appliances
- Low power AC Fan controllers

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Absolute	maximum rating	·			_	
V_{DRM}	repetitive peak off-state voltage		-	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 45 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	-	-	1	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; Fig. 4; Fig. 5	-	-	8	A
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms	-	-	8.5	А
Tj	junction temperature		-	-	125	°C
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u>	-	-	5	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G-};$ T _j = 25 °C; <u>Fig. 7</u>	-	-	5	mA
		V _D = 12 V; I _T = 0.1 A; T2- G-; T _i = 25 °C; <u>Fig. 7</u>	-	-	5	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2- G+};$ $\text{T}_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	7	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	10	mA
V _T	on-state voltage	I _τ = 1 A; T _i = 25 °C; <u>Fig. 10</u>		1.3	1.6	V

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Dynamic characteristics							
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 536 \text{ V}; \text{ T}_{\text{j}} = 110 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit; Fig. 12$		20	-	-	V/µs
dV _{com} /dt	rate of change of commutating voltage	$V_D = 400 \text{ V}; T_j = 110 \text{ °C}; dI_{com}/dt = 0.44$ A/ms; I _T = 1 A; gate open circuit		1	-	-	V/µs

5. Pinning information

Table 2. P	able 2. Pinning information									
Pin	Symbol	Description	Simplified outline	Graphic symbol						
1	T2	main terminal 2		N						
2	G	gate								
3	T1	main terminal 1	ЦЦЦ ЦЦ ТО-92 (SOT54)	sym051						

6. Ordering information

Table 3. Ordering information									
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date			
Z0107NA	TO92	Z0107NA,412	Bulk	1000	SOT54	14-Nov-2013			
Z0107NA	TO92	Z0107NA,126	Ammo	2000	SOT54 wide pitch	14-Nov-2013			
Z0107NA	TO92	Z0107NA,116	Reel	2000	SOT54 wide pitch	14-Nov-2013			
Z0107NA/DG	TO92	Z0107NA/DG,116	Reel	2000	SOT54 wide pitch	14-Nov-2013			

7. Marking

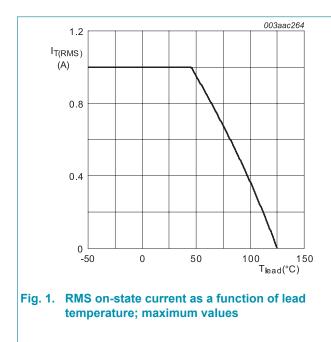
Table 4. Marking codes					
Type number	Marking codes				
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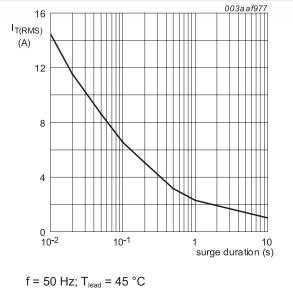
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

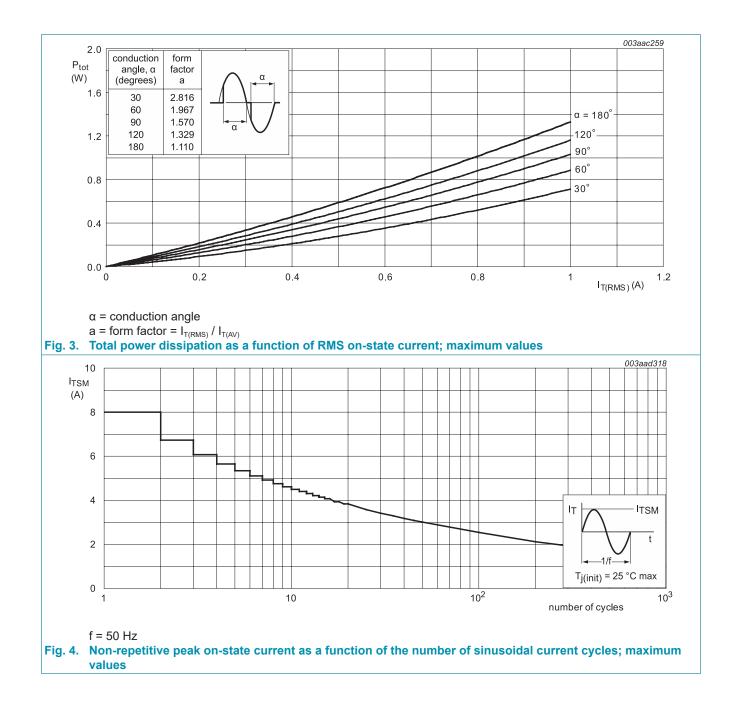
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 45 °C; <u>Fig. 1; Fig. 2</u> ; <u>Fig. 3</u>	-	1	А
I _{TSM}	non-repetitive peak on- state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; Fig. 4; Fig. 5	-	8	А
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms	-	8.5	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	0.32	A ² s
dl _⊤ /dt	rate of rise of on-state current	I _G = 10 mA	-	50	A/µs
		I _G = 10 mA	-	50	A/µs
		I _G = 14 mA	-	20	A/µs
		I _G = 10 mA	-	50	A/µs
I _{GM}	peak gate current		-	1	А
P _{GM}	peak gate power		-	2	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	150	°C
T _i	junction temperature		-	125	°C





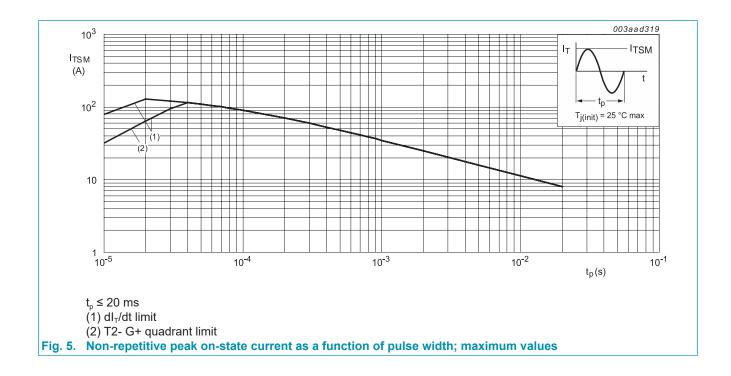


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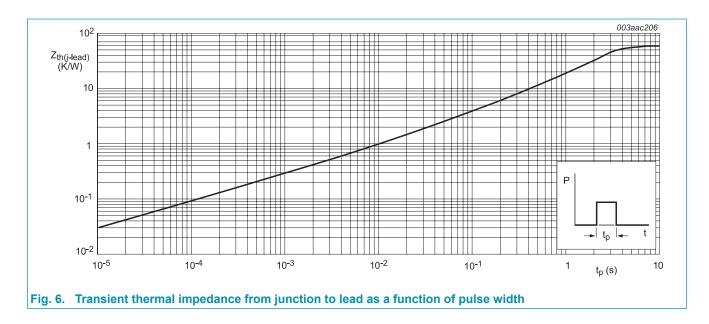
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9. Thermal characteristics

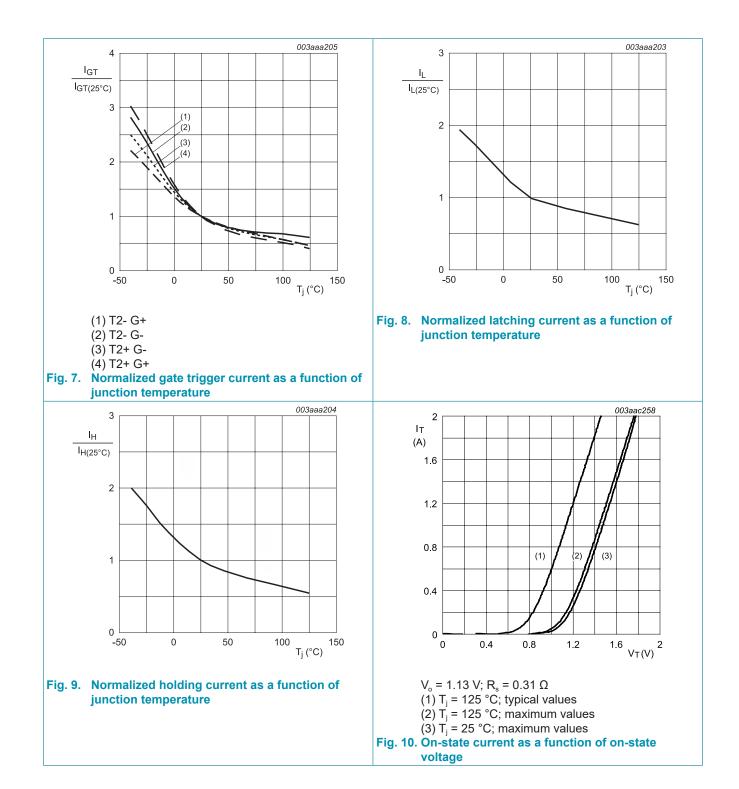
Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead	full cycle; <u>Fig. 6</u>	-	-	60	K/W
$R_{th(j\text{-}a)}$	thermal resistance from junction to ambient free air	full cycle; printed circuit board: lead length = 4 mm	-	150	-	K/W

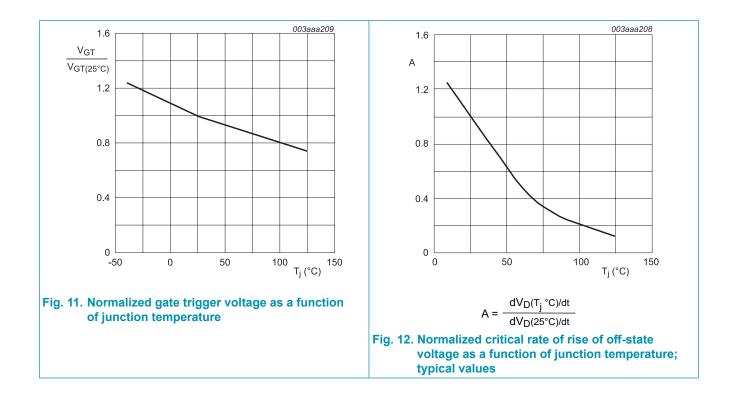


10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	aracteristics					
I _{GT}	gate trigger current	$V_{D} = 12 V; I_{T} = 0.1 A; T2+G+;$ T _j = 25 °C; Fig. 7	-	-	5	mA
		$V_{\rm D}$ = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; Fig. 7	-	-	5	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2- G-};$ T _j = 25 °C; Fig. 7	-	-	5	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2- G+};$ T _j = 25 °C; Fig. 7	-	-	7	mA
IL	latching current	V_{D} = 12 V; I _G = 0.1 A; T2+ G+; T _j = 25 °C; Fig. 8	-	-	10	mA
		V _D = 12 V; I _G = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 8</u>	-	-	20	mA
		V _D = 12 V; I _G = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 8</u>	-	-	10	mA
		$V_{\rm D}$ = 12 V; I _G = 0.1 A; T2- G+; T _j = 25 °C; Fig. 8	-	-	10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	10	mA
V _T	on-state voltage	I _T = 1 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.3	1.6	V
V _{GT}	gate trigger voltage	$V_{\rm D}$ = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 11	-	-	1	V
		$V_{\rm D}$ = 800 V; $I_{\rm T}$ = 0.1 A; $T_{\rm j}$ = 125 °C	0.2	-	-	V
I _D	off-state current	V _D = 800 V; T _j = 125 °C	-	-	0.5	mA
Dynamic	characteristics					
dV _D /dt	rate of rise of off-state voltage $V_{DM} = 536 \text{ V}; \text{ T}_{j} = 110 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM});$ exponential waveform; gate open circuit; Fig. 12		20	-	-	V/µs
dV _{com} /dt	rate of change of commutating voltage	V_{D} = 400 V; T _j = 110 °C; dI _{com} /dt = 0.44 A/ms; I _T = 1 A; gate open circuit	1	-	-	V/µs

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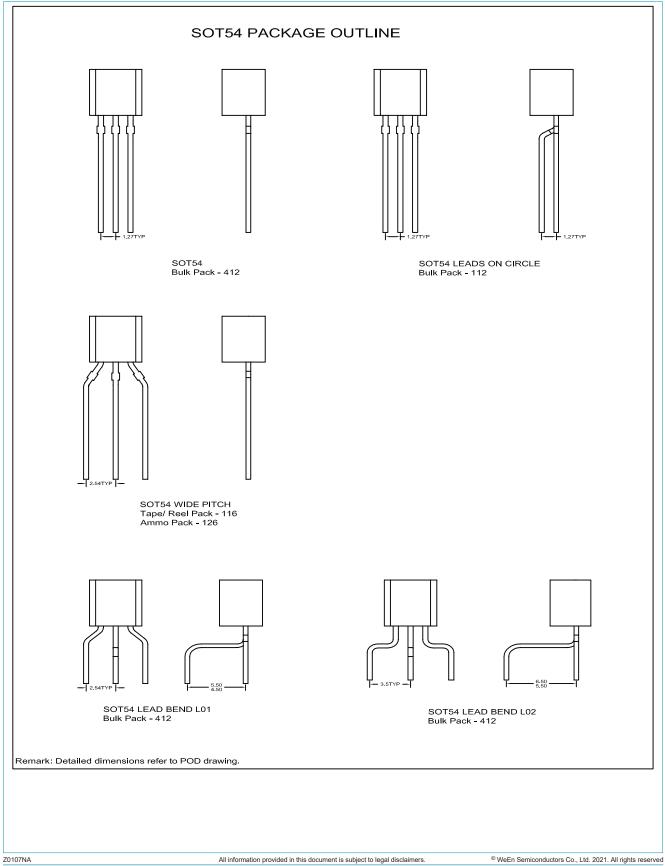


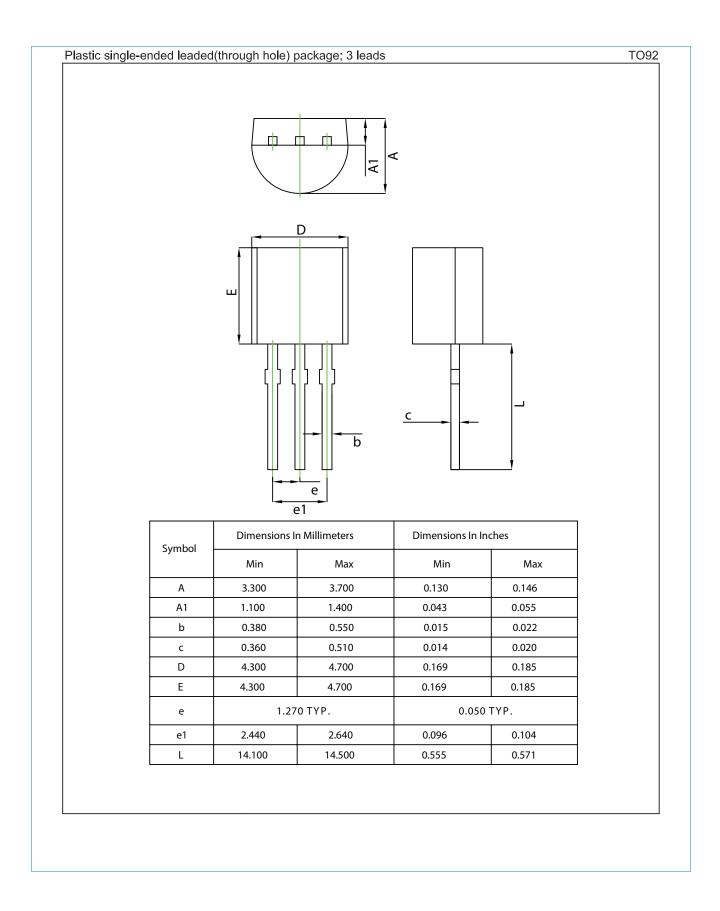


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11. Package outline





12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.ween-semi.com</u>.

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